

High-speed double diode Rev. 3 — 29 June 2010

Product data sheet

Product profile 1.

1.1 General description

Two high-speed switching diodes fabricated in planar technology, and encapsulated in a small SOT143B Surface-Mounted Device (SMD) plastic package. The diodes are not connected.

1.2 Features and benefits

■ High switching speed: $t_{rr} \le 6$ ns

Reverse voltage: V_R ≤ 60 V

Repetitive peak reverse voltage: V_{RRM} ≤ 60 V Repetitive peak forward current: I_{FRM} ≤ 600 mA

AEC-Q101 qualified

Small SMD plastic package

1.3 Applications

High-speed switching in e.g. surface-mounted circuits

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current		[1][2]	-	200	mA
I _R	reverse current	V _R = 60 V	-	-	100	nA
V_R	reverse voltage		-	-	60	V
t _{rr}	reverse recovery time		<u>[3]</u> _	-	6	ns

^[1] Single diode loaded.



^[2] Device mounted on an FR4 Printed-Circuit Board (PCB).

^[3] When switched from I_F = 400 mA to I_R = 400 mA; R_L = 100 Ω ; measured at I_R = 40 mA.

High-speed double diode

2. Pinning information

Table 2. Pinning

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	cathode (diode 1)		
2	cathode (diode 2)	4 3 — —	4 3
3	anode (diode 2)		
4	anode (diode 1)	1 2	
			1 2
			006aab100

3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
BAS56	-	plastic surface-mounted package; 4 leads	SOT143B	

4. Marking

Table 4. Marking codes

Type number	Marking code ^[1]
BAS56	*L5

- [1] * = -: made in Hong Kong
 - * = p: made in Hong Kong
 - * = t: made in Malaysia
 - * = W: made in China

High-speed double diode

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse		-	60	V
	voltage		[1] -	120	V
V_R	reverse voltage		-	60	V
			[1] -	120	V
l _F	forward current		[2][3]	200	mA
			[2][4]	150	mA
I _{FRM}	repetitive peak forward		[3] _	600	mA
	current		[4]	430	mA
I _{FSM}	non-repetitive peak forward current	square wave	<u>[5]</u>		
		t _p = 1 μs	-	9	Α
		t _p = 100 μs	-	3	Α
		t _p = 10 ms	-	1.7	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2] _	250	mW
Tj	junction temperature		-	150	°C
T _{stg}	storage temperature		–65	+150	°C

^[1] Series connection.

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	500	K/W
R _{th(j-t)}	thermal resistance from junction to tie-point		-	-	360	K/W

^[1] Device mounted on an FR4 PCB.

^[2] Device mounted on an FR4 PCB.

^[3] Single diode loaded.

^[4] Double diode loaded.

^[5] $T_j = 25$ °C prior to surge.

High-speed double diode

7. Characteristics

Table 7. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{F}	forward voltage	I _F = 200 mA	<u>[1]</u>	-	-	1	V
I _R	reverse current	V _R = 60 V		-	-	100	nA
		V _R = 60 V; T _j = 150 °C		-	-	100	μΑ
		V _R = 120 V	[2]	-	-	100	nA
		V _R = 120 V; T _j = 150 °C	[2]	-	-	100	μΑ
C _d	diode capacitance	$f = 1 MHz; V_R = 0 V$		-	-	2.5	pF
t _{rr}	reverse recovery time		[3]	-	-	6	ns
V_{FR}	forward recovery voltage		[4]	-	-	2	V
			[5]	-	-	1.5	V

^[1] $T_{amb} = 25$ °C; device has reached the thermal equilibrium when mounted on an FR4 PCB.

^[2] Series connection.

^[3] When switched from I_F = 400 mA to I_R = 400 mA; R_L = 100 Ω ; measured at I_R = 40 mA.

^[4] When switched from $I_F = 400$ mA; $t_r = 30$ ns.

^[5] When switched from $I_F = 400 \text{ mA}$; $t_r = 100 \text{ ns}$.

High-speed double diode

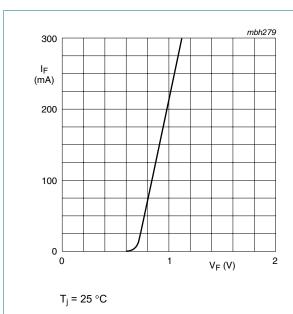
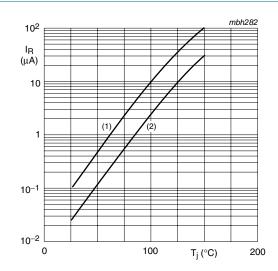


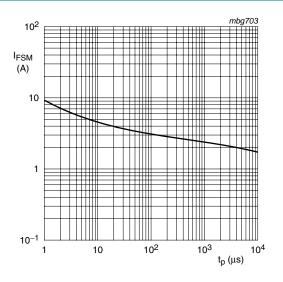
Fig 1. Forward current as a function of forward voltage; typical values



(1) $V_R = 60 \text{ V}$; maximum values

(2) $V_R = 60 \text{ V}$; typical values

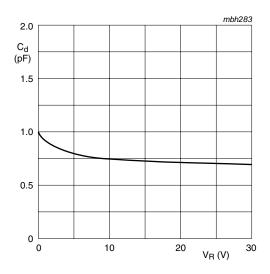
Fig 3. Reverse current as a function of junction temperature



Based on square wave currents.

T_i = 25 °C; prior to surge

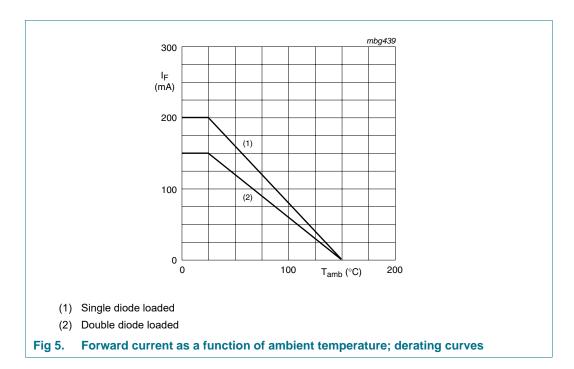
Fig 2. Non-repetitive peak forward current as a function of pulse duration



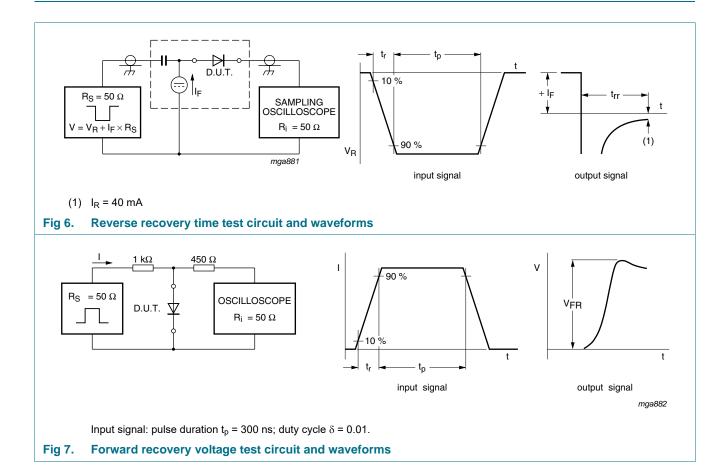
 $f = 1 \text{ MHz}; T_j = 25 ^{\circ}\text{C}$

Fig 4. Diode capacitance as a function of reverse voltage; typical values

High-speed double diode



8. Test information

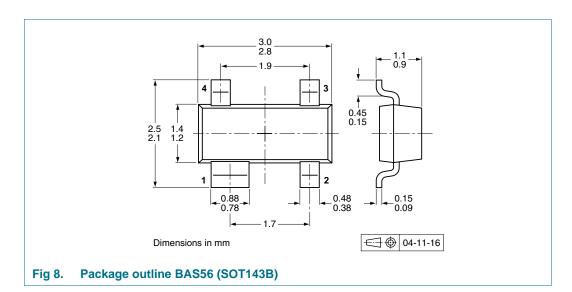


High-speed double diode

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline

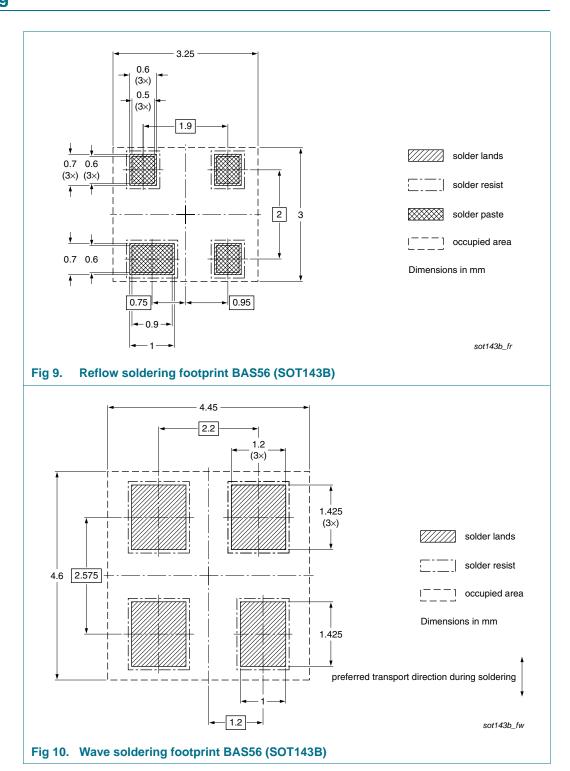


10. Packing information

Please refer to packing information on www.nexperia.com.

High-speed double diode

11. Soldering



High-speed double diode

12. Revision history

Table 9. Revision history

Release date	Data sheet status	Change notice	Supersedes			
20100629	Product data sheet	-	BAS56_2			
		redesigned to comply w	ith the new identity			
 Legal texts have been adapted to the new company name where appropriate. 						
Section 1.1 "General description": amended						
Section 4 "Marking": updated						
Table 1 "Quick reference data": added						
Section 8 "Test information": added						
• Figure 8: superseded by minimized package outline drawing						
Section 10 "Packing information": added						
Section 11 "Soldering": added						
Section 13 "I	Legal information": updated					
19960910	Product specification	-	BAS56_1			
19960423	Product specification	-	-			
	The format of guidelines of guidelines of the section 1.1 Section 4 "M Table 1 "Quidelines of the section 8 "To the section 8 "To the section 10 "Io the section 10 "Io the section 11 "Section 13 "Io the section 14 "Io the section 14 "Io the section 15 "Io the se	 20100629 Product data sheet The format of this data sheet has been guidelines of NXP Semiconductors. Legal texts have been adapted to the new Section 1.1 "General description": amer Section 4 "Marking": updated Table 1 "Quick reference data": added Section 8 "Test information": added Figure 8: superseded by minimized pact Section 10 "Packing information": added Section 11 "Soldering": added Section 13 "Legal information": updated 19960910 Product specification 	 The format of this data sheet has been redesigned to comply we guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name when section 1.1 "General description": amended Section 4 "Marking": updated Table 1 "Quick reference data": added Section 8 "Test information": added Figure 8: superseded by minimized package outline drawing Section 10 "Packing information": added Section 11 "Soldering": added Section 13 "Legal information": updated 19960910 Product specification - 			

High-speed double diode

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

BAS56

High-speed double diode

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

High-speed double diode

14. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 6
8.1	Quality information
9	Package outline
10	Packing information 7
11	Soldering 8
12	Revision history 9
13	Legal information
13.1	Data sheet status
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks11
14	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

All rights reserved.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Diodes - General Purpose, Power, Switching category:

Click to view products by Nexperia manufacturer:

Other Similar products are found below:

RD0306T-H BAV17-TR BAV19-TR 1N3611 NTE156A NTE525 NTE571 NTE5804 NTE5806 NTE6244 1SS181-TP 1SS193,LF

1SS400CST2RA SDAA13 SHN2D02FUTW1T1G LS4151GS08 1N4449 1N456A 1N4934-E3/73 1N914B 1N914BTR RFUH20TB3S

BAS 28 E6327 BAV199-TP BAW56DWQ-7-F BAW75-TAP MM230L-CAA IDW40E65D1 JAN1N3600 LL4151-GS18 053684A

SMMSD4148T3G 707803H NSVDAN222T1G SP000010217 CDSZC01100-HF BAV199E6433HTMA1 BAV70M3T5G SMBT2001T1G

NTE5801 NTE5800 NTE5808 NTE6240 NTE6248 BAS28-7 BAW56HDW-13 BAS28 TR VS-HFA04SD60STR-M3

NSVM1MA152WKT1G BAV99TQ-13-F